

flex division



pho**tronix**

technical data

Layers	2 to 16
Maximum panel size	600mm x 800mm
Materials	Polyimide, FR4
Maximum copper thickness	2 oz
Minimum hole size	0.20mm
Stiffeners	Polyimide, Rigid FR4, Metal
Thermabond adhesive	Thermosetting Adhesive: 3M High Adhesion Tape
Surface finishes	ENIG, HASL LF & HASL, OSP, Hard Gold Finger

Photronix work closely with our professional Chinese Flex/Flex-Rigid Circuit manufacturer, who are dedicated to produce quick-turn & Prototype, small to middle volume Flex & Flex-Rigid PCBs. Strictly following the requirement of ISO9001: 2008, ISO14001, all products meet the IPC, MIL & UL standards.

- 1 - 2 Layer Flex: From 3 Working Days
- 1 - 2 Layer Flex-Rigid: From 5 Working Days
- Shipping: 2-3 Working Days

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FS 585340